



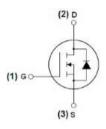
MJ N-Channel Enhancement Mode Power MOSFET

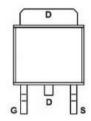
Description

The MJ5080K uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ightharpoonup VDS =50V,ID =80A RDS(ON) <7.5mΩ @ VGS=10V RDS(ON) <9mΩ @ VGS=4.5V
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- Good stability and uniformity with high Eas
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



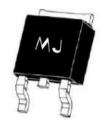


Application

Load switching

Hard switched and high frequency circuits

Uninterruptible power supply



Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ5080K	MJ5080K	TO-252-2L	a <u>~</u>	-	-

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	50	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	80	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	56.5	А
Pulsed Drain Current	Ірм	320	А
Maximum Power Dissipation	Po	100	W
Derating factor		0.67	W/°C
Single pulse avalanche energy (Note 5)	Eas	400	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.5	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	'					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	50	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =50V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	Igss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·			•		
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250μA	1.0	1.5	2.5	V
Dutie Ocean Oc Olds Buditans		V _{GS} =10V, I _D =20A	-	5.6	7.5	mΩ
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =4.5V, I _D =15A	-	6.7	9	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =20A	-	20	-	S
Dynamic Characteristics (Note 4)		1				
Input Capacitance	Clss		-	3600	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V F=1.0MHz	-	340	_	PF
Reverse Transfer Capacitance	Crss		-	230	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	V _{DD} =25V, RL=1Ω	-	30	_	nS
Turn-Off Delay Time	td(off)	$V_{GS}=10V,R_{G}=3\Omega$	-	45	_	nS
Turn-Off Fall Time	t _f		_	31	-	nS
Total Gate Charge	Qg		-	65	_	nC
Gate-Source Charge	Qgs	V _{DS} =25V,I _D =20A V _{GS} =10V	_	13	_	nC
Gate-Drain Charge	Q _{gd}	- VGS-10V	_	20	_	nC
Drain-Source Diode Characteristics						<u> </u>
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =20A	_	_	1.2	V
Diode Forward Current (Note 2)	Is	,	_	_	80	A
Reverse Recovery Time	trr		_	36		nS
Reverse Recovery Charge	urr Qrr	TJ=25°C, IF=20A di/dt=100A/µs (Note 3)	_	48	_	nC

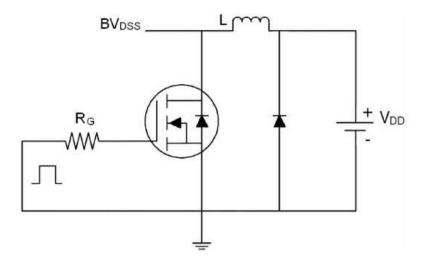
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production

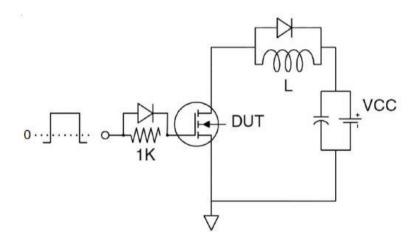




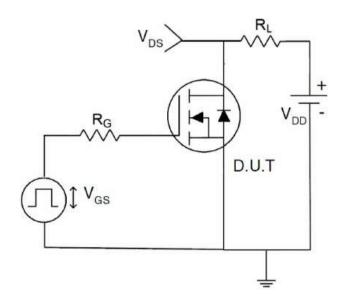
Test circuit



Eas test Circuit



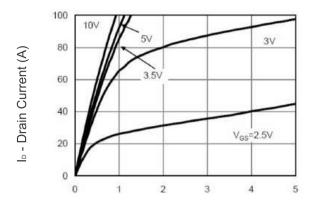
Gate charge test Circuit

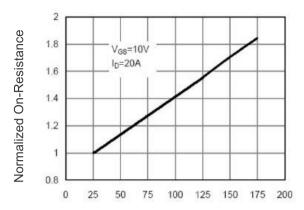


Switch Time Test Circuit



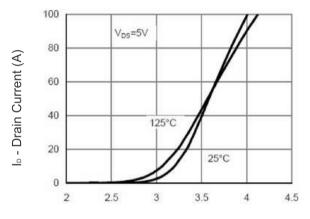
Typical Electrical and Thermal Characteristics (Curves)

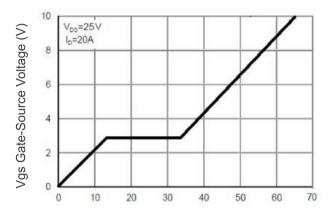




Vds Drain-Source Voltage (V)

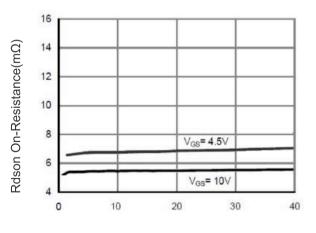
T_J -Junction Temperature(°C) Figure 1 Output Characteristics Figure 4 Rdson-Junction Temperature

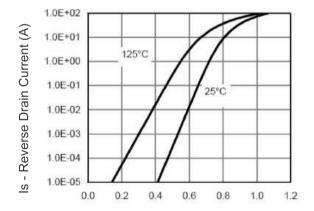




Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

Qg Gate Charge (nC) Figure 5 Gate Charge



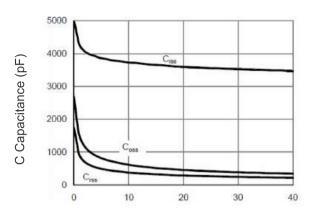


ID - Drain Current (A) Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



Ib - Drain Current (A)

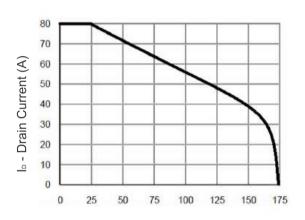


120 100 Power Dissipation (W) 80 60 40 20 0 0 25 50 75 100 125 150 175

Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

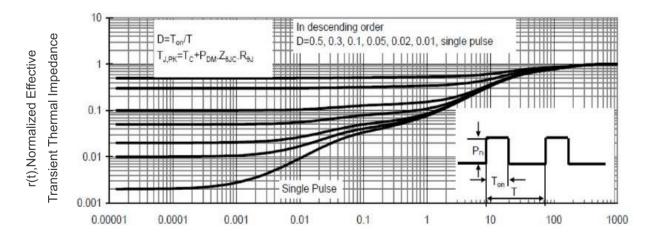
1000.0 10us 100.0 100us 1ms 10.0 1.0 T_{J(Max)}=175°C 0.1 T_C=25°C 0.0 0.01 0.1 10 100 1

T_J-Junction Temperature (°C) Figure 9 Power De-rating



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

T_J-Junction Temperature (°C) Figure 10 Current De-rating



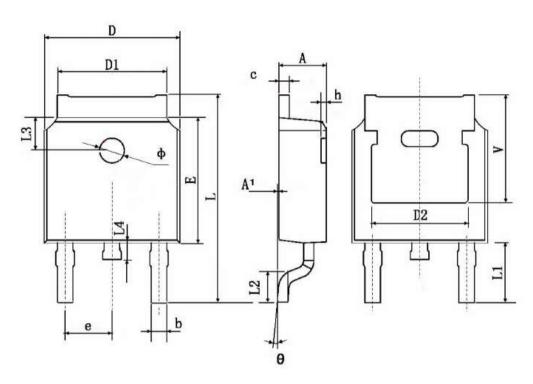
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	n Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350	TYP.	0.211	TYP.





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